

Title (en)

Method for determining initial burnishing parameters

Title (de)

Verfahren zur Bestimmung von anfänglichen Festwalzparametern

Title (fr)

Procédé pour la détermination de paramètres de brunissage initiaux

Publication

**EP 1938926 A1 20080702 (EN)**

Application

**EP 07123705 A 20071219**

Priority

US 61875506 A 20061230

Abstract (en)

A method of determining parameters for a burnishing operation includes: using a rolling burnishing element (11) to burnish at least two segments (14) on a selected surface (12) of a material sample (13), the segments (14) having a common width (W) and overlapping each other by a preselected overlap value (OV); measuring the resulting hardness of the surface (12); and selecting a working overlap value (OV) for a subsequent burnishing operation on a workpiece (WP), based on the measured hardness.

IPC 8 full level

**B24B 39/00** (2006.01); **C21D 7/08** (2006.01); **C22F 1/00** (2006.01)

CPC (source: EP US)

**B24B 39/00** (2013.01 - EP US); **B24B 39/003** (2013.01 - EP US); **C21D 1/55** (2013.01 - EP US); **C21D 7/08** (2013.01 - EP US); **C22F 1/183** (2013.01 - EP US); **Y10T 29/47** (2015.01 - EP US); **Y10T 29/474** (2015.01 - EP US); **Y10T 29/49764** (2015.01 - EP US); **Y10T 29/49771** (2015.01 - EP US); **Y10T 29/49776** (2015.01 - EP US); **Y10T 29/49778** (2015.01 - EP US)

Citation (search report)

- [A] US 2005155203 A1 20050721 - PREVEY PAUL S [US]
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- [A] EP 1426139 A1 20040609 - SURFACE TECHNOLOGY HOLDINGS [US]

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FR2983101A1; WO2012066113A1

Designated contracting state (EPC)

DE FR GB

Designated extension state (EPC)

AL BA HR MK RS

DOCDB simple family (publication)

**EP 1938926 A1 20080702**; **EP 1938926 B1 20100407**; CN 101209538 A 20080702; CN 101209538 B 20120125; DE 602007005761 D1 20100520; JP 2008162011 A 20080717; JP 5268351 B2 20130821; SG 144088 A1 20080729; SG 162833 A1 20100729; US 2008160891 A1 20080703; US 8079120 B2 20111220

DOCDB simple family (application)

**EP 07123705 A 20071219**; CN 200710307262 A 20071228; DE 602007005761 T 20071219; JP 2007338683 A 20071228; SG 2007187123 A 20071214; SG 2010046233 A 20071214; US 61875506 A 20061230